

Global Solder Paste Market by Size, by Type, by Application, by Region, History and Forecast 2019-2030

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Abstracts

Solder paste is a suspension of solder particles in a solder flux, which is widely used in the electronic assembly materials.

According to APO Research, The global Solder Paste market is projected to grow from US\$ million in 2024 to US\$ million by 2030, at a Compound Annual Growth Rate (CAGR) of % during the forecast period.

The global solder paste is a fully developed industry. The largest sales market is China, due to the rapidly development of electronics industry, with above 40% share.

The major players of Solder Paste are Senju, MacDermid Alpha Electronics Solutions and Heraeus captured the top three revenue share spots in the Solder Paste market. They take about 45% of the market.

In terms of production side, this report researches the Solder Paste production, growth rate, market share by manufacturers and by region (region level and country level), from 2019 to 2024, and forecast to 2030.

In terms of consumption side, this report focuses on the sales of Solder Paste by region (region level and country level), by company, by type and by application. from 2019 to 2024 and forecast to 2030.

This report presents an overview of global market for Solder Paste, capacity, output, revenue and price. Analyses of the global market trends, with historic market revenue or sales data for 2019 - 2023, estimates for 2024, and projections of CAGR through 2030.

This report researches the key producers of Solder Paste, also provides the consumption of main regions and countries. Of the upcoming market potential for Solder Paste, and key regions or countries of focus to forecast this market into various segments and sub-segments. Country specific data and market value analysis for the U.S., Canada, Mexico, Brazil, China, Japan, South Korea, Southeast Asia, India, Germany, the U.K., Italy, Middle East, Africa, and Other Countries.

This report focuses on the Solder Paste sales, revenue, market share and industry ranking of main manufacturers, data from 2019 to 2024. Identification of the major stakeholders in the global Solder Paste market, and analysis of their competitive landscape and market positioning based on recent developments and segmental revenues. This report will help stakeholders to understand the competitive landscape and gain more insights and position their businesses and market strategies in a better way.

This report analyzes the segments data by type and by application, sales, revenue, and price, from 2019 to 2030. Evaluation and forecast the market size for Solder Paste sales, projected growth trends, production technology, application and end-user industry.

Descriptive company profiles of the major global players, including Senju, Alent (Alpha), Tamura, Henkel, Indium, Kester (ITW), Shengmao, Inventec and KOKI, etc.

Solder Paste segment by Company

Senju

Alent (Alpha)

Tamura

Henkel

Indium

Kester (ITW)

Shengmao

Inventec

KOKI

AIM

Nihon Superior

KAWADA

Yashida

Tongfang Tech

Shenzhen Bright

Yong An

Solder Paste segment by Type

Resin Based Pastes

Water Soluble Fluxes

No-clean Flux

Solder Paste segment by Application

SMT Assembly

Semiconductor Packaging

Solder Paste segment by Region

North America

U.S.

Canada

Europe

Germany

France

U.K.

Italy

Russia

Asia-Pacific

China

Japan

South Korea

India

Australia

China Taiwan

Indonesia

Thailand

Malaysia

Latin America

Mexico

Brazil

Argentina

Middle East & Africa

Turkey

Saudi Arabia

UAE

Study Objectives

1. To analyze and research the global status and future forecast, involving, production, value, consumption, growth rate (CAGR), market share, historical and forecast.
2. To present the key manufacturers, capacity, production, revenue, market share, and Recent Developments.
3. To split the breakdown data by regions, type, manufacturers, and Application.
4. To analyze the global and key regions market potential and advantage, opportunity and challenge, restraints, and risks.
5. To identify significant trends, drivers, influence factors in global and regions.
6. To analyze competitive developments such as expansions, agreements, new product launches, and acquisitions in the market.

Reasons to Buy This Report

1. This report will help the readers to understand the competition within the industries and strategies for the competitive environment to enhance the potential profit. The report also focuses on the competitive landscape of the global Solder Paste market, and introduces in detail the market share, industry ranking, competitor ecosystem, market

performance, new product development, operation situation, expansion, and acquisition. etc. of the main players, which helps the readers to identify the main competitors and deeply understand the competition pattern of the market.

2. This report will help stakeholders to understand the global industry status and trends of Solder Paste and provides them with information on key market drivers, restraints, challenges, and opportunities.

3. This report will help stakeholders to understand competitors better and gain more insights to strengthen their position in their businesses. The competitive landscape section includes the market share and rank (in volume and value), competitor ecosystem, new product development, expansion, and acquisition.

4. This report stays updated with novel technology integration, features, and the latest developments in the market.

5. This report helps stakeholders to gain insights into which regions to target globally.

6. This report helps stakeholders to gain insights into the end-user perception concerning the adoption of Solder Paste.

7. This report helps stakeholders to identify some of the key players in the market and understand their valuable contribution.

Chapter Outline

Chapter 1: Provides an overview of the Solder Paste market, including product definition, global market growth prospects, production value, capacity, and average price forecasts (2019-2030).

Chapter 2: Analysis key trends, drivers, challenges, and opportunities within the global Solder Paste industry.

Chapter 3: Detailed analysis of Solder Paste market competition landscape. Including Solder Paste manufacturers' output value, output and average price from 2019 to 2024, as well as competition analysis indicators such as origin, product type, application, merger and acquisition information, etc.

Chapter 4: Provides the analysis of various market segments by type, covering the

market size and development potential of each market segment, to help readers find the blue ocean market in different market segments.

Chapter 5: Provides the analysis of various market segments by application, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different downstream markets.

Chapter 6: Provides profiles of key players, introducing the basic situation of the main companies in the market in detail, including product production/output, value, price, gross margin, product introduction, recent development, etc.

Chapter 7: Production/Production Value of Solder Paste by region. It provides a quantitative analysis of the market size and development potential of each region in the next six years.

Chapter 8: Consumption of Solder Paste in regional level and country level. It provides a quantitative analysis of the market size and development potential of each region and its main countries and introduces the market development, future development prospects, market space, and production of each country in the world.

Chapter 9: Analysis of industrial chain, including the upstream and downstream of the industry.

Chapter 10: Concluding Insights of the report.

Contents

1 MARKET OVERVIEW

- 1.1 Product Definition
- 1.2 Global Market Growth Prospects
 - 1.2.1 Global Solder Paste Production Value Estimates and Forecasts (2019-2030)
 - 1.2.2 Global Solder Paste Production Capacity Estimates and Forecasts (2019-2030)
 - 1.2.3 Global Solder Paste Production Estimates and Forecasts (2019-2030)
 - 1.2.4 Global Solder Paste Market Average Price (2019-2030)
- 1.3 Assumptions and Limitations
- 1.4 Study Goals and Objectives

2 GLOBAL SOLDER PASTE MARKET DYNAMICS

- 2.1 Solder Paste Industry Trends
- 2.2 Solder Paste Industry Drivers
- 2.3 Solder Paste Industry Opportunities and Challenges
- 2.4 Solder Paste Industry Restraints

3 SOLDER PASTE MARKET BY MANUFACTURERS

- 3.1 Global Solder Paste Production Value by Manufacturers (2019-2024)
- 3.2 Global Solder Paste Production by Manufacturers (2019-2024)
- 3.3 Global Solder Paste Average Price by Manufacturers (2019-2024)
- 3.4 Global Solder Paste Industry Manufacturers Ranking, 2022 VS 2023 VS 2024
- 3.5 Global Solder Paste Key Manufacturers Manufacturing Sites & Headquarters
- 3.6 Global Solder Paste Manufacturers, Product Type & Application
- 3.7 Global Solder Paste Manufacturers Commercialization Time
- 3.8 Market Competitive Analysis
 - 3.8.1 Global Solder Paste Market CR5 and HHI
 - 3.8.2 Global Top 5 and 10 Solder Paste Players Market Share by Production Value in 2023
 - 3.8.3 2023 Solder Paste Tier 1, Tier 2, and Tier

4 SOLDER PASTE MARKET BY TYPE

- 4.1 Solder Paste Type Introduction
 - 4.1.1 Resin Based Pastes

- 4.1.2 Water Soluble Fluxes
- 4.1.3 No-clean Flux
- 4.2 Global Solder Paste Production by Type
 - 4.2.1 Global Solder Paste Production by Type (2019 VS 2023 VS 2030)
 - 4.2.2 Global Solder Paste Production by Type (2019-2030)
 - 4.2.3 Global Solder Paste Production Market Share by Type (2019-2030)
- 4.3 Global Solder Paste Production Value by Type
 - 4.3.1 Global Solder Paste Production Value by Type (2019 VS 2023 VS 2030)
 - 4.3.2 Global Solder Paste Production Value by Type (2019-2030)
 - 4.3.3 Global Solder Paste Production Value Market Share by Type (2019-2030)

5 SOLDER PASTE MARKET BY APPLICATION

- 5.1 Solder Paste Application Introduction
 - 5.1.1 SMT Assembly
 - 5.1.2 Semiconductor Packaging
- 5.2 Global Solder Paste Production by Application
 - 5.2.1 Global Solder Paste Production by Application (2019 VS 2023 VS 2030)
 - 5.2.2 Global Solder Paste Production by Application (2019-2030)
 - 5.2.3 Global Solder Paste Production Market Share by Application (2019-2030)
- 5.3 Global Solder Paste Production Value by Application
 - 5.3.1 Global Solder Paste Production Value by Application (2019 VS 2023 VS 2030)
 - 5.3.2 Global Solder Paste Production Value by Application (2019-2030)
 - 5.3.3 Global Solder Paste Production Value Market Share by Application (2019-2030)

6 COMPANY PROFILES

- 6.1 Senju
 - 6.1.1 Senju Company Information
 - 6.1.2 Senju Business Overview
 - 6.1.3 Senju Solder Paste Production, Value and Gross Margin (2019-2024)
 - 6.1.4 Senju Solder Paste Product Portfolio
 - 6.1.5 Senju Recent Developments
- 6.2 Alent (Alpha)
 - 6.2.1 Alent (Alpha) Company Information
 - 6.2.2 Alent (Alpha) Business Overview
 - 6.2.3 Alent (Alpha) Solder Paste Production, Value and Gross Margin (2019-2024)
 - 6.2.4 Alent (Alpha) Solder Paste Product Portfolio
 - 6.2.5 Alent (Alpha) Recent Developments

6.3 Tamura

6.3.1 Tamura Company Information

6.3.2 Tamura Business Overview

6.3.3 Tamura Solder Paste Production, Value and Gross Margin (2019-2024)

6.3.4 Tamura Solder Paste Product Portfolio

6.3.5 Tamura Recent Developments

6.4 Henkel

6.4.1 Henkel Company Information

6.4.2 Henkel Business Overview

6.4.3 Henkel Solder Paste Production, Value and Gross Margin (2019-2024)

6.4.4 Henkel Solder Paste Product Portfolio

6.4.5 Henkel Recent Developments

6.5 Indium

6.5.1 Indium Company Information

6.5.2 Indium Business Overview

6.5.3 Indium Solder Paste Production, Value and Gross Margin (2019-2024)

6.5.4 Indium Solder Paste Product Portfolio

6.5.5 Indium Recent Developments

6.6 Kester (ITW)

6.6.1 Kester (ITW) Company Information

6.6.2 Kester (ITW) Business Overview

6.6.3 Kester (ITW) Solder Paste Production, Value and Gross Margin (2019-2024)

6.6.4 Kester (ITW) Solder Paste Product Portfolio

6.6.5 Kester (ITW) Recent Developments

6.7 Shengmao

6.7.1 Shengmao Company Information

6.7.2 Shengmao Business Overview

6.7.3 Shengmao Solder Paste Production, Value and Gross Margin (2019-2024)

6.7.4 Shengmao Solder Paste Product Portfolio

6.7.5 Shengmao Recent Developments

6.8 Inventec

6.8.1 Inventec Company Information

6.8.2 Inventec Business Overview

6.8.3 Inventec Solder Paste Production, Value and Gross Margin (2019-2024)

6.8.4 Inventec Solder Paste Product Portfolio

6.8.5 Inventec Recent Developments

6.9 KOKI

6.9.1 KOKI Company Information

6.9.2 KOKI Business Overview

- 6.9.3 KOKI Solder Paste Production, Value and Gross Margin (2019-2024)
- 6.9.4 KOKI Solder Paste Product Portfolio
- 6.9.5 KOKI Recent Developments
- 6.10 AIM
 - 6.10.1 AIM Company Information
 - 6.10.2 AIM Business Overview
 - 6.10.3 AIM Solder Paste Production, Value and Gross Margin (2019-2024)
 - 6.10.4 AIM Solder Paste Product Portfolio
 - 6.10.5 AIM Recent Developments
- 6.11 Nihon Superior
 - 6.11.1 Nihon Superior Company Information
 - 6.11.2 Nihon Superior Business Overview
 - 6.11.3 Nihon Superior Solder Paste Production, Value and Gross Margin (2019-2024)
 - 6.11.4 Nihon Superior Solder Paste Product Portfolio
 - 6.11.5 Nihon Superior Recent Developments
- 6.12 KAWADA
 - 6.12.1 KAWADA Company Information
 - 6.12.2 KAWADA Business Overview
 - 6.12.3 KAWADA Solder Paste Production, Value and Gross Margin (2019-2024)
 - 6.12.4 KAWADA Solder Paste Product Portfolio
 - 6.12.5 KAWADA Recent Developments
- 6.13 Yashida
 - 6.13.1 Yashida Company Information
 - 6.13.2 Yashida Business Overview
 - 6.13.3 Yashida Solder Paste Production, Value and Gross Margin (2019-2024)
 - 6.13.4 Yashida Solder Paste Product Portfolio
 - 6.13.5 Yashida Recent Developments
- 6.14 Tongfang Tech
 - 6.14.1 Tongfang Tech Company Information
 - 6.14.2 Tongfang Tech Business Overview
 - 6.14.3 Tongfang Tech Solder Paste Production, Value and Gross Margin (2019-2024)
 - 6.14.4 Tongfang Tech Solder Paste Product Portfolio
 - 6.14.5 Tongfang Tech Recent Developments
- 6.15 Shenzhen Bright
 - 6.15.1 Shenzhen Bright Company Information
 - 6.15.2 Shenzhen Bright Business Overview
 - 6.15.3 Shenzhen Bright Solder Paste Production, Value and Gross Margin (2019-2024)
 - 6.15.4 Shenzhen Bright Solder Paste Product Portfolio

- 6.15.5 Shenzhen Bright Recent Developments
- 6.16 Yong An
 - 6.16.1 Yong An Comapny Information
 - 6.16.2 Yong An Business Overview
 - 6.16.3 Yong An Solder Paste Production, Value and Gross Margin (2019-2024)
 - 6.16.4 Yong An Solder Paste Product Portfolio
 - 6.16.5 Yong An Recent Developments

7 GLOBAL SOLDER PASTE PRODUCTION BY REGION

- 7.1 Global Solder Paste Production by Region: 2019 VS 2023 VS 2030
- 7.2 Global Solder Paste Production by Region (2019-2030)
 - 7.2.1 Global Solder Paste Production by Region: 2019-2024
 - 7.2.2 Global Solder Paste Production by Region (2025-2030)
- 7.3 Global Solder Paste Production by Region: 2019 VS 2023 VS 2030
- 7.4 Global Solder Paste Production Value by Region (2019-2030)
 - 7.4.1 Global Solder Paste Production Value by Region: 2019-2024
 - 7.4.2 Global Solder Paste Production Value by Region (2025-2030)
- 7.5 Global Solder Paste Market Price Analysis by Region (2019-2024)
- 7.6 Regional Production Value Trends (2019-2030)
 - 7.6.1 North America Solder Paste Production Value (2019-2030)
 - 7.6.2 Europe Solder Paste Production Value (2019-2030)
 - 7.6.3 Asia-Pacific Solder Paste Production Value (2019-2030)
 - 7.6.4 Latin America Solder Paste Production Value (2019-2030)
 - 7.6.5 Middle East & Africa Solder Paste Production Value (2019-2030)

8 GLOBAL SOLDER PASTE CONSUMPTION BY REGION

- 8.1 Global Solder Paste Consumption by Region: 2019 VS 2023 VS 2030
- 8.2 Global Solder Paste Consumption by Region (2019-2030)
 - 8.2.1 Global Solder Paste Consumption by Region (2019-2024)
 - 8.2.2 Global Solder Paste Consumption by Region (2025-2030)
- 8.3 North America
 - 8.3.1 North America Solder Paste Consumption Growth Rate by Country: 2019 VS 2023 VS 2030
 - 8.3.2 North America Solder Paste Consumption by Country (2019-2030)
 - 8.3.3 U.S.
 - 8.3.4 Canada
- 8.4 Europe

8.4.1 Europe Solder Paste Consumption Growth Rate by Country: 2019 VS 2023 VS 2030

8.4.2 Europe Solder Paste Consumption by Country (2019-2030)

8.4.3 Germany

8.4.4 France

8.4.5 U.K.

8.4.6 Italy

8.4.7 Netherlands

8.5 Asia Pacific

8.5.1 Asia Pacific Solder Paste Consumption Growth Rate by Country: 2019 VS 2023 VS 2030

8.5.2 Asia Pacific Solder Paste Consumption by Country (2019-2030)

8.5.3 China

8.5.4 Japan

8.5.5 South Korea

8.5.6 Southeast Asia

8.5.7 India

8.5.8 Australia

8.6 LAMEA

8.6.1 LAMEA Solder Paste Consumption Growth Rate by Country: 2019 VS 2023 VS 2030

8.6.2 LAMEA Solder Paste Consumption by Country (2019-2030)

8.6.3 Mexico

8.6.4 Brazil

8.6.5 Turkey

8.6.6 GCC Countries

9 VALUE CHAIN AND SALES CHANNELS ANALYSIS

9.1 Solder Paste Value Chain Analysis

9.1.1 Solder Paste Key Raw Materials

9.1.2 Raw Materials Key Suppliers

9.1.3 Manufacturing Cost Structure

9.1.4 Solder Paste Production Mode & Process

9.2 Solder Paste Sales Channels Analysis

9.2.1 Direct Comparison with Distribution Share

9.2.2 Solder Paste Distributors

9.2.3 Solder Paste Customers

10 CONCLUDING INSIGHTS

11 APPENDIX

11.1 Reasons for Doing This Study

11.2 Research Methodology

11.3 Research Process

11.4 Authors List of This Report

11.5 Data Source

11.5.1 Secondary Sources

11.5.2 Primary Sources

11.6 Disclaimer

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